TOSHIBA Photocoupler Photorelay

TLP197D

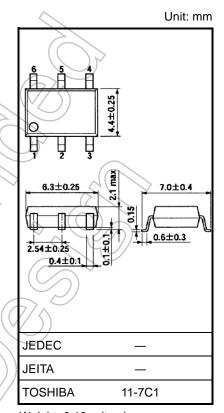
PC Card Modems PBX

Measurement Equipment

The Toshiba TLP197D consists of an infrared emitting diode optically coupled to a photo-MOSFET in a SOP package.

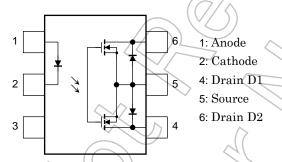
TLP197D is housed in a compact and thin SOP package and has characteristics of high-withstanding voltage and low ON-state resistance, which enable TLP197D to be applied in hook switches, dial-pulse switches for modems and facsimiles, and switches for test circuit switching in PBXs.

- 6-pin SOP (2.54SOP6): Height = 2.1 mm, pitch = 2.54 mm
- Normally open (1-form-A) device
- Peak OFF-state voltage: 200 V (min)
- Trigger LED current: 3 mA (max)
- ON-state current: 200 mA (max)
- ON-state resistance: 8 Ω (max)
- Isolation voltage: 1500 Vrms (min)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349

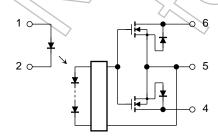


Weight: 0.13 g (typ.)

Pin Configuration (top view)



Schematic



Start of commercial production 2002-02

Absolute Maximum Ratings (Ta = 25°C)

						I
	Chara	acteristics	Symbol	Rating	Unit	
	Forward current		lF	50	mA	
	Forward current of	ΔIF/°C	-0.5	mA/°C		
	Peak forward current (100 μs pulse, 100 pps)		IFP	1	А	
LED	Reverse voltage	Reverse voltage			V	
	Diode power diss	ipation	PD	50	mW	((
	Diode power diss	ipation derating (Ta≥25°C)	△P _D /°C	-0.5	mW/°C	
	Junction tempera	ture	Tj	125	%C	$(\bigcirc / <$
	Off-state output to	erminal voltage	Voff	200	V	
		A connection		200		
	On-state current	B connection	Ion	200	mA	J)~
		C connection		400		
	On-state current derating (Ta ≥25°C)	A connection		-2.0		7
		B connection	Δl _{ON} /°C	-2.0	mA/°C	
ctor		C connection		-4.0	())	\Diamond
Detector		A connection				` <
_	Output power dissipation	B connection	Po	300	mW	0
	,	C connection	<			
	Output power	A connection				5). <
	dissipation derating	B connection	ΔΡο/℃	-3.0	mW /°C	// 5)
	(Ta ≥ 25°C)	C connection	4			
	Junction temperature		Ţ,	125 🗸	°C //	
Operating temperature range			Topr	-40 to 85	ပို	
Storage temperature range			√ stg	-55 to 125	°C	
Lead	soldering tempera	ature (10 s)	T _{sol}	260	°C	
	tion voltage 60 s, R.H. ≤ 60 %) (Note 1)	BVs	1500	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

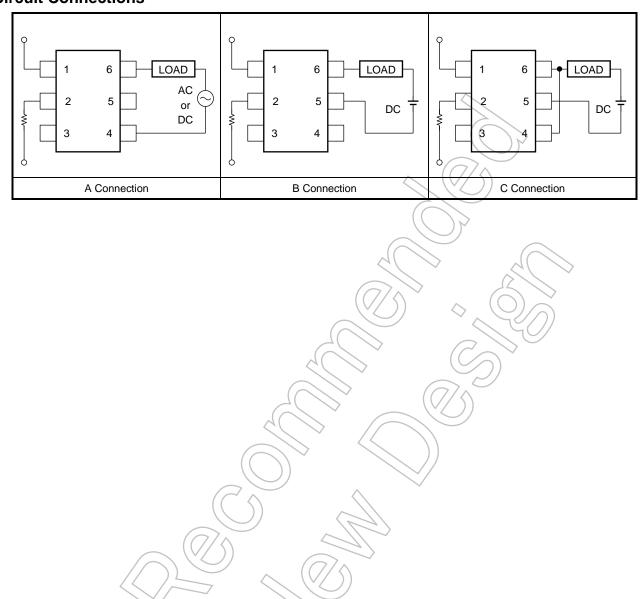
Note 1: Pins 1, 2 and 3 are shorted together, and pins 4, 5 and 6 are shorted together.

Recommended Operating Conditions

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	V _{DD}	_	_	160	٧
Forward current	l _F	5	7.5	25	mA
On-state current	Ion	1		130	mA
Operating temperature	Topr	-20	_	60	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Circuit Connections



Electrical Characteristics (Ta = 25°C)

	Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	I _F = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I _R	V _R = 5 V	_	_	10	μА
	Capacitance	Ст	VF = 0 V, f = 1 MHz	/_	30	_	рF
ector	Off-state current	loff	V _{OFF} = 200 V		7	1	μΑ
Detector	Capacitance	Coff	V = 0 V, f = 1 MHz	$\left(\right)$	100		pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current		lfT	ION = 200 mA		d (1	3	mA
Return LED current		IFC	IOFF = 100 μA	0.1		, –	mA
	A connection		ION = 200 mA, IF = 5 mA	+))5	8	
On-state resistance	B connection	Ron	ION = 200 mA, IF = 5 mA	1	(3//	5	Ω
	C connection		ION = 400 mA, I _F = 5 mA	7	1.4	_	

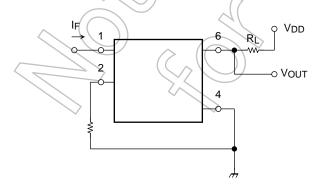
Isolation Characteristics (Ta = 25°C)

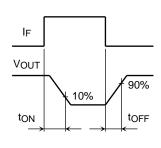
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	es	V _S = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation resistance	Rs	V _S = 500 V, R.H. ≤ 60 %	5 × 10 ¹⁰	10 ¹⁴	_	Ω
Isolation voltage	BVs	AC, 60 s	1500		_	Vrms

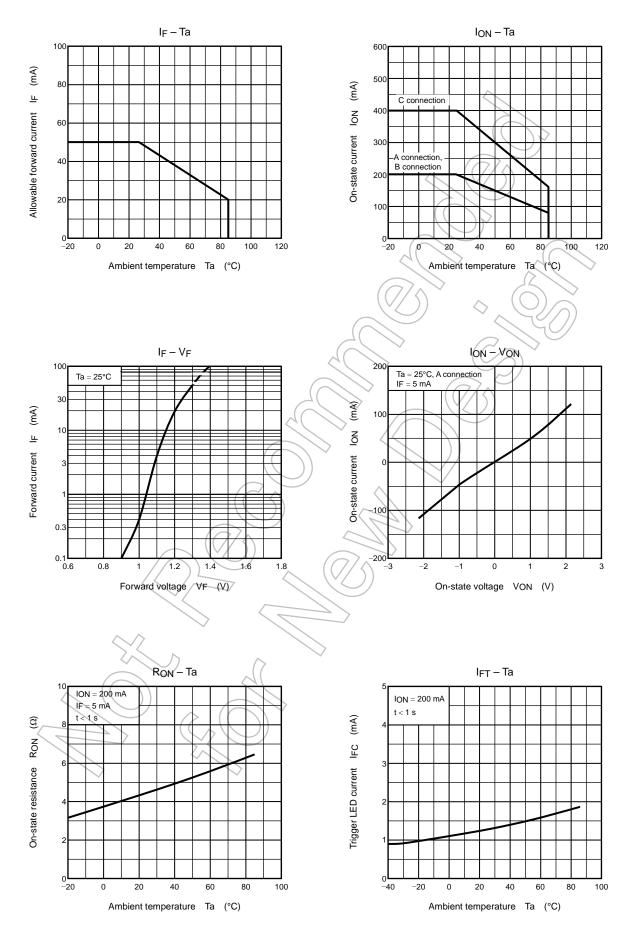
Switching Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition		Min	Тур.	Max	Unit
Turn-on time	ton	$R_L = 200 \Omega$ (Not	e 2)		0.6	1.5	ms
Turn-off time	toff	$V_{DD} = 20 \text{ V, IF} = 5 \text{ mA}$		_	0.1	1.0	ms

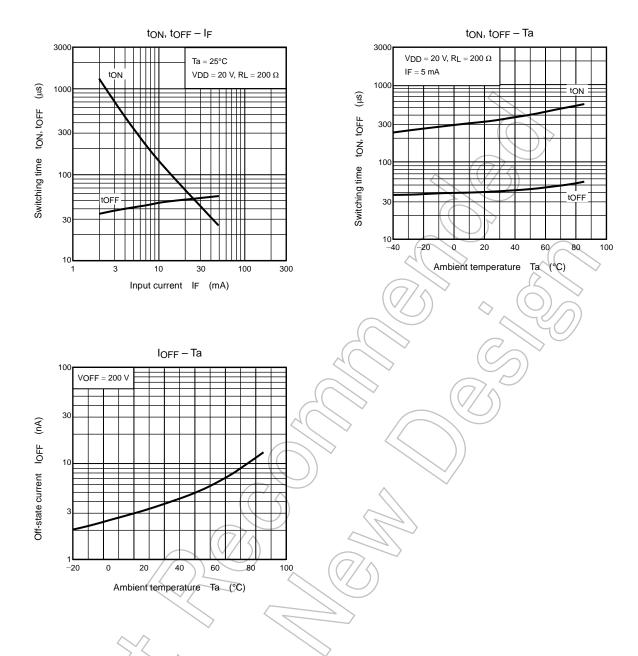
Note 2: Switching time test circuit







NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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